

# BGA771L16

High Linearity Dual-Band UMTS LNA  
(1900/1800/2100, 800/900 MHz)

Small Signal Discretes



Never stop thinking

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**BGA771L16****Revision History: 2008-08-26, V3.0****Previous Version: 2008-07-17, V2.1 preliminary**

| <b>Page</b> | <b>Subjects (major changes since last revision)</b> |
|-------------|-----------------------------------------------------|
| 6           | Updated value for thermal resistance                |
| 8           | Added supply current characteristics                |
|             |                                                     |
|             |                                                     |
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## 1 Description

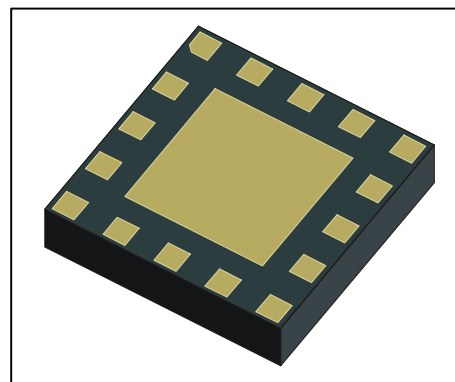
The BGA771L16 is a highly flexible, high linearity dual-band (1900/1800/2100, 800/900 MHz) low noise amplifier MMIC for worldwide use. Based on Infineon's proprietary and cost-effective SiGe:C technology, the BGA771L16 uses an advanced biasing concept in order to achieve high linearity.

The device features dynamic gain control, temperature stabilization, standby mode, and 2 kV ESD protection on-chip as well as matching off chip. Because the matching is off chip, different UMTS bands can be easily applied. For example, the 1900 MHz path can be converted into a 1800 MHz or a 2100 MHz path by optimizing the input and output matching network.

*Note: UMTS bands II / V is the standard band combination for this product requiring no external output matching network.*

### Features

- Gain: 16 / -7.5 dB in high / low gain mode (all bands)
- Noise figure: 1.1 / 1.1 dB in high gain mode (800 MHz / 1900 MHz)
- Supply current: 3.4 / 0.65 mA in high / low gain mode (all bands)
- Standby mode (< 2  $\mu$ A typ.)
- Output internally matched to 50  $\Omega$
- Inputs pre-matched to 50  $\Omega$
- 2kV HBM ESD protection
- Low external component count
- Small leadless TSLP-16-1 package (2.3 x 2.3 x 0.39 mm)
- Pb-free (RoHS compliant) package



TSLP-16-1 package

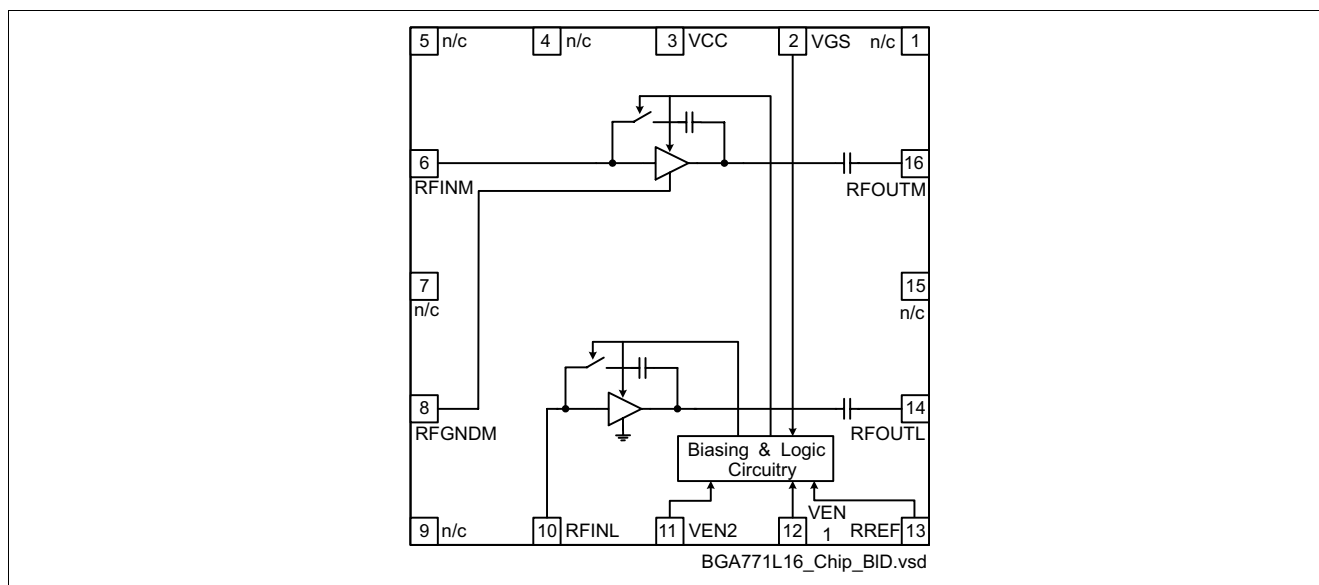


Figure 1 Block diagram of dual-band LNA

| Type      | Package   | Marking | Chip  |
|-----------|-----------|---------|-------|
| BGA771L16 | TSLP-16-1 | BGA771  | T1530 |

## 2 Electrical Characteristics

### 2.1 Absolute Maximum Ratings

**Table 1 Absolute Maximum Ratings**

| Parameter                 | Symbol     | Values |              | Unit | Note / Test Condition         |
|---------------------------|------------|--------|--------------|------|-------------------------------|
|                           |            | Min.   | Max.         |      |                               |
| Supply voltage            | $V_{CC}$   | -0.3   | 3.6          | V    |                               |
| Supply current            | $I_{CC}$   |        | 10           | mA   |                               |
| Pin voltage               | $V_{PIN}$  | -0.3   | $V_{CC}+0.3$ | V    | All pins except RF input pins |
| Pin voltage RF Input Pins | $V_{RFIN}$ | -0.3   | 0.9          | V    |                               |
| RF input power            | $P_{RFIN}$ |        | 4            | dBm  |                               |
| Junction temperature      | $T_j$      |        | 150          | °C   |                               |
| Ambient temperature range | $T_A$      | -30    | 85           | °C   |                               |
| Storage temperature range | $T_{stg}$  | -65    | 150          | °C   |                               |

### 2.2 Thermal Resistance

**Table 2 Thermal Resistance**

| Parameter                                      | Symbol     | Value | Unit | Note / Test Conditions |
|------------------------------------------------|------------|-------|------|------------------------|
| Thermal resistance junction to soldering point | $R_{thJS}$ | ≤ 37  | K/W  |                        |

### 2.3 ESD Integrity

**Table 3 ESD Integrity**

| Parameter                      | Symbol        | Value (typ.) | Unit | Note / Test Conditions |
|--------------------------------|---------------|--------------|------|------------------------|
| ESD hardness HBM <sup>1)</sup> | $V_{ESD-HBM}$ | 2000         | V    | All pins               |

1) According to JESD22-A114

## 2.4 DC Characteristics

**Table 4** DC Characteristics,  $T_A = 25\text{ }^{\circ}\text{C}$

| Parameter                     | Symbol      | Values |      |      | Unit          | Note / Test Condition |
|-------------------------------|-------------|--------|------|------|---------------|-----------------------|
|                               |             | Min.   | Typ. | Max. |               |                       |
| Supply voltage                | $V_{CC}$    | 2.7    | 2.8  | 3.0  | V             |                       |
| Supply current high gain mode | $I_{CCHG}$  |        | 3.4  |      | mA            | All bands             |
| Supply current low gain mode  | $I_{CCLG}$  |        | 650  |      | $\mu\text{A}$ | All bands             |
| Supply current standby mode   | $I_{CCOFF}$ |        | 0.1  | 2    | $\mu\text{A}$ |                       |
| Logic level high              | $V_{HI}$    | 1.5    | 2.8  |      | V             | VEN1, VEN2 and VGS    |
| Logic level low               | $V_{LO}$    |        | 0.0  | 0.5  | V             |                       |
| Logic currents VEN            | $I_{ENL}$   |        | 0.2  |      | $\mu\text{A}$ | VEN1 and VEN2         |
|                               | $I_{ENH}$   |        | 10.0 |      | $\mu\text{A}$ |                       |
| Logic currents VGS            | $I_{GSL}$   |        | 0.1  |      | $\mu\text{A}$ | VGS                   |
|                               | $I_{GSH}$   |        | 5.0  |      | $\mu\text{A}$ |                       |

## 2.5 Band Select / Gain Control Truth Table

**Table 5** Band Select Truth Table,  $V_{CC} = 2.8\text{ V}$

|      | Mid band | Low band | Power Down |
|------|----------|----------|------------|
| VEN1 | H        | L        | L          |
| VEN2 | L        | H        | L          |

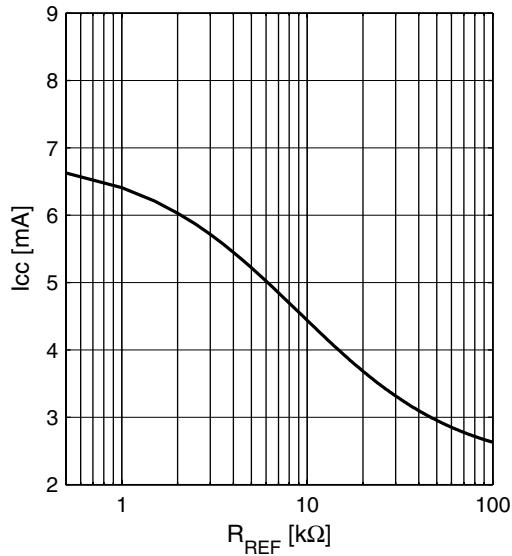
**Table 6** Gain Control Truth Table,  $V_{CC} = 2.8\text{ V}$

|     | High Gain | Low Gain |
|-----|-----------|----------|
| VGS | H         | L        |

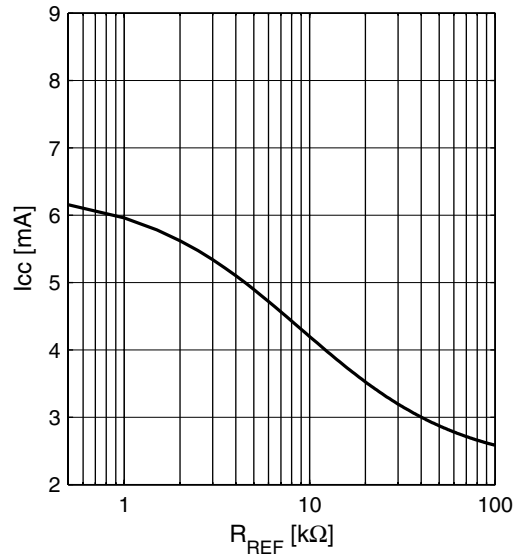
## 2.6 Supply current characteristics; $T_A = 25\text{ °C}$

Supply current high / mid gain mode versus reference resistor  $R_{REF}$  (see [Figure 2 on page 25](#) for reference resistor; low gain mode supply current is independent of reference resistor).

**Supply Current Midband**  $I_{CC} = f(R_{REF})$   
 $V_{CC} = 2.8\text{ V}$



**Supply Current Lowband**  $I_{CC} = f(R_{REF})$   
 $V_{CC} = 2.8\text{ V}$

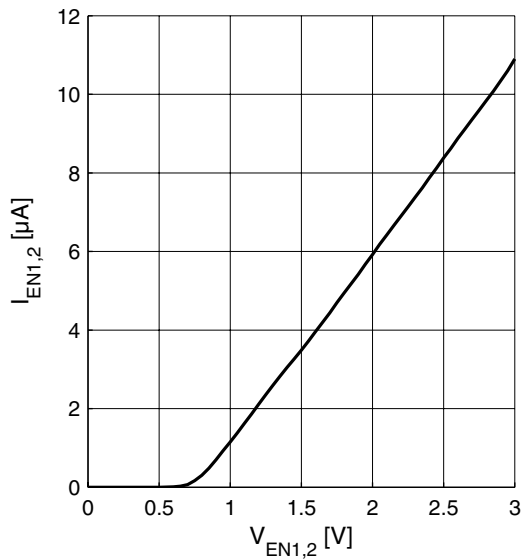




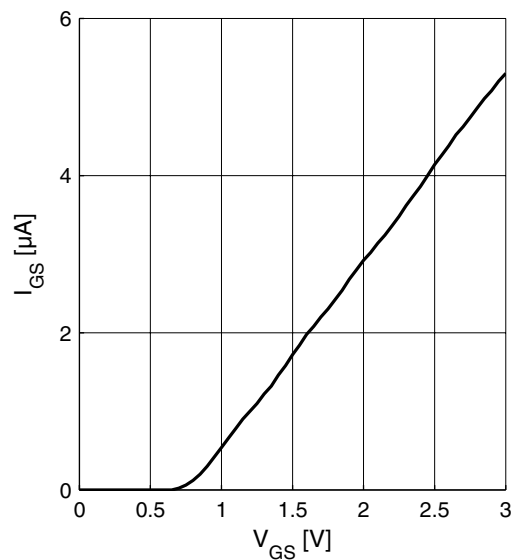
## 2.7 Logic Signal Characteristics; $T_A = 25\text{ °C}$

Current consumption of logic inputs VEN1, VEN2, VGS

**Logic currents**  $I_{EN1,2} = f(V_{EN1,2})$   
 $V_{CC} = 2.8\text{ V}$



**Logic currents**  $I_{GS} = f(V_{GS})$   
 $V_{CC} = 2.8\text{ V}$



## 2.8 Switching Times

**Table 7** Typical switching times;  $T_A = -30 \dots 85\text{ °C}$

| Parameter                | Symbol   | Values |      |      | Unit | Note / Test Condition                       |
|--------------------------|----------|--------|------|------|------|---------------------------------------------|
|                          |          | Min.   | Typ. | Max. |      |                                             |
| Settling time gainstep   | $t_{GS}$ |        | 1    |      | μs   | Switching LG ↔ HG all bands                 |
| Settling time bandselect | $t_{BS}$ |        | 1    |      | μs   | Switching from any band to a different band |

## 2.9 Measured RF Characteristics Low Band

### 2.9.1 Measured RF Characteristics UMTS Bands V / VI

**Table 8 Typical Characteristics 800 MHz Band,  $T_A = 25\text{ °C}$ ,  $V_{CC} = 2.8\text{ V}$**

| Parameter                                                                                     | Symbol       | Values |      |      | Unit | Note / Test Condition        |
|-----------------------------------------------------------------------------------------------|--------------|--------|------|------|------|------------------------------|
|                                                                                               |              | Min.   | Typ. | Max. |      |                              |
| Pass band range band V                                                                        |              | 869    |      | 894  | MHz  |                              |
| Pass band range band VI                                                                       |              | 875    |      | 885  | MHz  |                              |
| Current consumption                                                                           | $I_{CCHG}$   |        | 3.4  |      | mA   | High gain mode               |
|                                                                                               | $I_{CCLG}$   |        | 0.65 |      | mA   | Low gain mode                |
| Gain                                                                                          | $S_{21HG}$   |        | 16.1 |      | dB   | High gain mode               |
|                                                                                               | $S_{21LG}$   |        | -7.5 |      | dB   | Low gain mode                |
| Reverse Isolation <sup>1)</sup>                                                               | $S_{12HG}$   |        | -36  |      | dB   | High gain mode               |
|                                                                                               | $S_{12LG}$   |        | -8   |      | dB   | Low gain mode                |
| Noise figure                                                                                  | $NF_{HG}$    |        | 1.1  |      | dB   | High gain mode               |
|                                                                                               | $NF_{LG}$    |        | 7.5  |      | dB   | Low gain mode                |
| Input return loss <sup>1)</sup>                                                               | $S_{11HG}$   |        | -17  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{11LG}$   |        | -17  |      | dB   | 50 $\Omega$ , low gain mode  |
| Output return loss <sup>1)</sup>                                                              | $S_{22HG}$   |        | -17  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{22LG}$   |        | -13  |      | dB   | 50 $\Omega$ , low gain mode  |
| Stability factor <sup>2)</sup>                                                                | $k$          |        | >2.3 |      |      | DC to 10 GHz; all gain modes |
| Input compression point <sup>1)</sup>                                                         | $IP_{1dBHG}$ |        | -6   |      | dBm  | High gain mode               |
|                                                                                               | $IP_{1dBLG}$ |        | -8   |      | dBm  | Low gain mode                |
| Inband IIP3 <sup>1)</sup><br>$f_1 - f_2 = 1\text{ MHz}$<br>$P_{f1} = P_{f2} = -37\text{ dBm}$ | $IIP3_{HG}$  |        | -7   |      | dBm  | High gain mode               |
|                                                                                               | $IIP3_{LG}$  |        | 2    |      |      | Low gain mode                |

1) Verified by random sampling; not 100% RF tested

2) Not tested in production; guaranteed by device design

## 2.9.2 Measured RF Characteristics UMTS Band VIII

**Table 9** Typical Characteristics 900 MHz Band,  $T_A = 25\text{ °C}$ ,  $V_{CC} = 2.8\text{ V}$

| Parameter                                                                                     | Symbol        | Values |      |      | Unit | Note / Test Condition        |
|-----------------------------------------------------------------------------------------------|---------------|--------|------|------|------|------------------------------|
|                                                                                               |               | Min.   | Typ. | Max. |      |                              |
| Pass band range                                                                               |               | 925    |      | 960  | MHz  |                              |
| Current consumption                                                                           | $I_{CCHG}$    |        | 3.4  |      | mA   | High gain mode               |
|                                                                                               | $I_{CCLG}$    |        | 0.65 |      | mA   | Low gain mode                |
| Gain                                                                                          | $S_{21HG}$    |        | 16.1 |      | dB   | High gain mode               |
|                                                                                               | $S_{21LG}$    |        | -7.1 |      | dB   | Low gain mode                |
| Reverse Isolation <sup>1)</sup>                                                               | $S_{12HG}$    |        | -36  |      | dB   | High gain mode               |
|                                                                                               | $S_{12LG}$    |        | -7   |      | dB   | Low gain mode                |
| Noise figure                                                                                  | $NF_{HG}$     |        | 1.1  |      | dB   | High gain mode               |
|                                                                                               | $NF_{LG}$     |        | 7.1  |      | dB   | Low gain mode                |
| Input return loss <sup>1)</sup>                                                               | $S_{11HG}$    |        | -16  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{11LG}$    |        | -15  |      | dB   | 50 $\Omega$ , low gain mode  |
| Output return loss <sup>1)</sup>                                                              | $S_{22HG}$    |        | -15  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{22LG}$    |        | -16  |      | dB   | 50 $\Omega$ , low gain mode  |
| Stability factor <sup>2)</sup>                                                                | $k$           |        | >2.3 |      |      | DC to 10 GHz; all gain modes |
| Input compression point <sup>1)</sup>                                                         | $IP_{1dBHG}$  |        | -5   |      | dBm  | High gain mode               |
|                                                                                               | $IP_{1dB LG}$ |        | -8   |      | dBm  | Low gain mode                |
| Inband IIP3 <sup>1)</sup><br>$f_1 - f_2 = 1\text{ MHz}$<br>$P_{f1} = P_{f2} = -37\text{ dBm}$ | $IIP3_{HG}$   |        | -6   |      | dBm  | High gain mode               |
|                                                                                               | $IIP3_{LG}$   |        | 2    |      |      | Low gain mode                |

1) Verified by random sampling; not 100% RF tested

2) Not tested in production; guaranteed by device design

## 2.10 Measured RF Characteristics Mid Band

### 2.10.1 Measured RF Characteristics UMTS Band II

**Table 10** Typical Characteristics 1900 MHz Band,  $T_A = 25^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$

| Parameter                                                                                     | Symbol        | Values |      |      | Unit | Note / Test Condition        |
|-----------------------------------------------------------------------------------------------|---------------|--------|------|------|------|------------------------------|
|                                                                                               |               | Min.   | Typ. | Max. |      |                              |
| Pass band range                                                                               |               | 1930   |      | 1990 | MHz  |                              |
| Current consumption                                                                           | $I_{CCHG}$    |        | 3.4  |      | mA   | High gain mode               |
|                                                                                               | $I_{CCLG}$    |        | 0.65 |      | mA   | Low gain mode                |
| Gain                                                                                          | $S_{21HG}$    |        | 16.0 |      | dB   | High gain mode               |
|                                                                                               | $S_{21LG}$    |        | -7.8 |      | dB   | Low gain mode                |
| Reverse Isolation <sup>1)</sup>                                                               | $S_{12HG}$    |        | -35  |      | dB   | High gain mode               |
|                                                                                               | $S_{12LG}$    |        | -8   |      | dB   | Low gain mode                |
| Noise figure                                                                                  | $NF_{HG}$     |        | 1.1  |      | dB   | High gain mode               |
|                                                                                               | $NF_{LG}$     |        | 7.8  |      | dB   | Low gain mode                |
| Input return loss <sup>1)</sup>                                                               | $S_{11HG}$    |        | -19  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{11LG}$    |        | -18  |      | dB   | 50 $\Omega$ , low gain mode  |
| Output return loss <sup>1)</sup>                                                              | $S_{22HG}$    |        | -20  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{22LG}$    |        | -15  |      | dB   | 50 $\Omega$ , low gain mode  |
| Stability factor <sup>2)</sup>                                                                | $k$           |        | >2.4 |      |      | DC to 10 GHz; all gain modes |
| Input compression point <sup>1)</sup>                                                         | $IP_{1dBHG}$  |        | -7   |      | dBm  | High gain mode               |
|                                                                                               | $IP_{1dB LG}$ |        | -7   |      | dBm  | Low gain mode                |
| Inband IIP3 <sup>1)</sup><br>$f_1 - f_2 = 1\text{ MHz}$<br>$P_{f1} = P_{f2} = -37\text{ dBm}$ | $IIP3_{HG}$   |        | -6   |      | dBm  | High gain mode               |
|                                                                                               | $IIP3_{LG}$   |        | 3    |      |      | Low gain mode                |

1) Verified by random sampling; not 100% RF tested

2) Not tested in production; guaranteed by device design

## 2.10.2 Measured RF Characteristics UMTS Bands III / IX

**Table 11 Typical Characteristics 1800 MHz Band,  $T_A = 25\text{ °C}$ ,  $V_{CC} = 2.8\text{ V}$**

| Parameter                                                                                     | Symbol        | Values |      |        | Unit | Note / Test Condition        |
|-----------------------------------------------------------------------------------------------|---------------|--------|------|--------|------|------------------------------|
|                                                                                               |               | Min.   | Typ. | Max.   |      |                              |
| Pass band range band III                                                                      |               | 1805   |      | 1880   | MHz  |                              |
| Pass band range band IX                                                                       |               | 1844.9 |      | 1879.9 | MHz  |                              |
| Current consumption                                                                           | $I_{CCHG}$    |        | 3.4  |        | mA   | High gain mode               |
|                                                                                               | $I_{CCLG}$    |        | 0.65 |        | mA   | Low gain mode                |
| Gain                                                                                          | $S_{21HG}$    |        | 16.2 |        | dB   | High gain mode               |
|                                                                                               | $S_{21LG}$    |        | -8.7 |        | dB   | Low gain mode                |
| Reverse Isolation <sup>1)</sup>                                                               | $S_{12HG}$    |        | -36  |        | dB   | High gain mode               |
|                                                                                               | $S_{12LG}$    |        | -9   |        | dB   | Low gain mode                |
| Noise figure                                                                                  | $NF_{HG}$     |        | 1.0  |        | dB   | High gain mode               |
|                                                                                               | $NF_{LG}$     |        | 8.7  |        | dB   | Low gain mode                |
| Input return loss <sup>1)</sup>                                                               | $S_{11HG}$    |        | -13  |        | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{11LG}$    |        | -14  |        | dB   | 50 $\Omega$ , low gain mode  |
| Output return loss <sup>1)</sup>                                                              | $S_{22HG}$    |        | -19  |        | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{22LG}$    |        | -15  |        | dB   | 50 $\Omega$ , low gain mode  |
| Stability factor <sup>2)</sup>                                                                | $k$           |        | >2.5 |        |      | DC to 10 GHz; all gain modes |
| Input compression point <sup>1)</sup>                                                         | $IP_{1dBHG}$  |        | -7   |        | dBm  | High gain mode               |
|                                                                                               | $IP_{1dB LG}$ |        | -6   |        | dBm  | Low gain mode                |
| Inband IIP3 <sup>1)</sup><br>$f_1 - f_2 = 1\text{ MHz}$<br>$P_{f1} = P_{f2} = -37\text{ dBm}$ | $IIP3_{HG}$   |        | -5   |        | dBm  | High gain mode               |
|                                                                                               | $IIP3_{LG}$   |        | 3    |        |      | Low gain mode                |

1) Verified by random sampling; not 100% RF tested

2) Not tested in production; guaranteed by device design

### 2.10.3 Measured RF Characteristics UMTS Band IV

**Table 12 Typical Characteristics 2100 MHz Band,  $T_A = 25\text{ °C}$ ,  $V_{CC} = 2.8\text{ V}$**

| Parameter                                                                                     | Symbol       | Values |      |      | Unit | Note / Test Condition        |
|-----------------------------------------------------------------------------------------------|--------------|--------|------|------|------|------------------------------|
|                                                                                               |              | Min.   | Typ. | Max. |      |                              |
| Pass band range                                                                               |              | 2110   |      | 2155 | MHz  |                              |
| Current consumption                                                                           | $I_{CCHG}$   |        | 3.4  |      | mA   | High gain mode               |
|                                                                                               | $I_{CCLG}$   |        | 0.65 |      | mA   | Low gain mode                |
| Gain                                                                                          | $S_{21HG}$   |        | 15.8 |      | dB   | High gain mode               |
|                                                                                               | $S_{21LG}$   |        | -7.0 |      | dB   | Low gain mode                |
| Reverse Isolation <sup>1)</sup>                                                               | $S_{12HG}$   |        | -34  |      | dB   | High gain mode               |
|                                                                                               | $S_{12LG}$   |        | -7   |      | dB   | Low gain mode                |
| Noise figure                                                                                  | $NF_{HG}$    |        | 1.1  |      | dB   | High gain mode               |
|                                                                                               | $NF_{LG}$    |        | 7    |      | dB   | Low gain mode                |
| Input return loss <sup>1)</sup>                                                               | $S_{11HG}$   |        | -19  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{11LG}$   |        | -14  |      | dB   | 50 $\Omega$ , low gain mode  |
| Output return loss <sup>1)</sup>                                                              | $S_{22HG}$   |        | -19  |      | dB   | 50 $\Omega$ , high gain mode |
|                                                                                               | $S_{22LG}$   |        | -15  |      | dB   | 50 $\Omega$ , low gain mode  |
| Stability factor <sup>2)</sup>                                                                | $k$          |        | >2.3 |      |      | DC to 10 GHz; all gain modes |
| Input compression point <sup>1)</sup>                                                         | $IP_{1dBHG}$ |        | -7   |      | dBm  | High gain mode               |
|                                                                                               | $IP_{1dBLG}$ |        | -4   |      | dBm  | Low gain mode                |
| Inband IIP3 <sup>1)</sup><br>$f_1 - f_2 = 1\text{ MHz}$<br>$P_{f1} = P_{f2} = -37\text{ dBm}$ | $IIP3_{HG}$  |        | -4   |      | dBm  | High gain mode               |
|                                                                                               | $IIP3_{LG}$  |        | 6    |      |      | Low gain mode                |

1) Verified by random sampling; not 100% RF tested

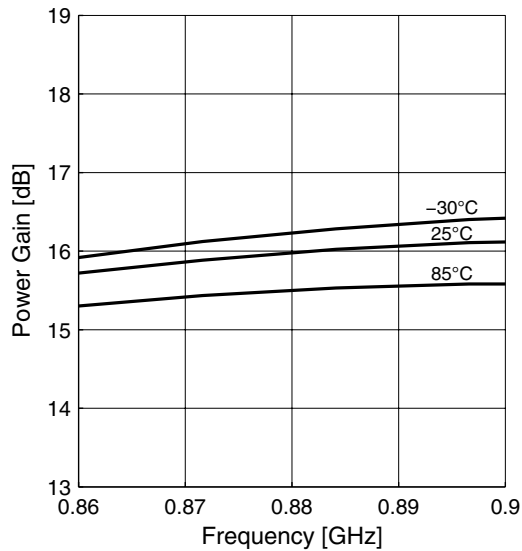
2) Not tested in production; guaranteed by device design

**Measured Performance Low Band (Band V) High Gain Mode vs. Frequency**

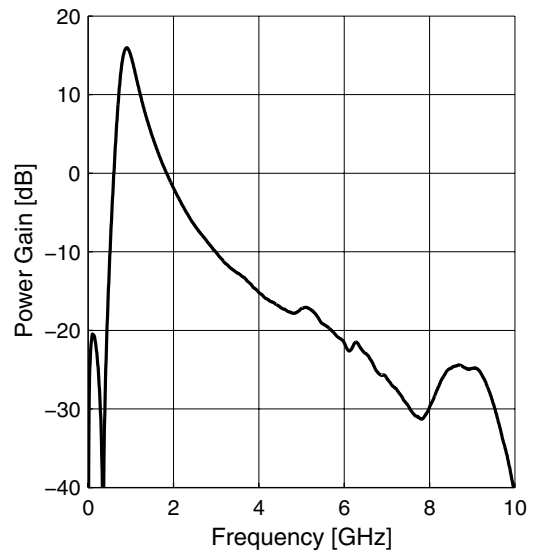
**2.11 Measured Performance Low Band (Band V) High Gain Mode vs. Frequency**

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$ ,  $V_{GS} = 2.8\text{ V}$ ,  $V_{EN1} = 0\text{ V}$ ,  $V_{EN2} = 2.8\text{ V}$

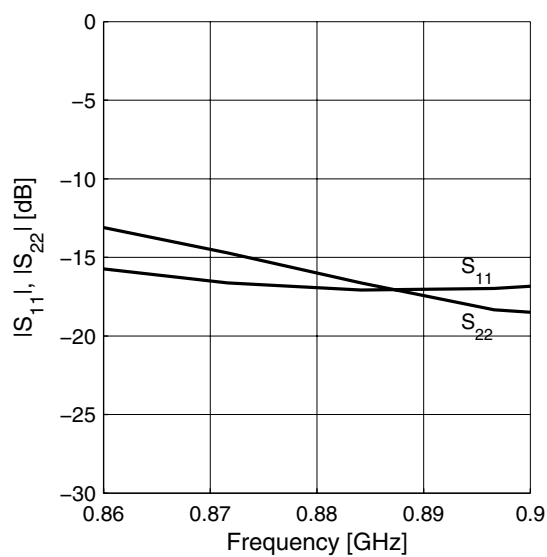
**Power Gain**  $|S_{21}| = f(f)$



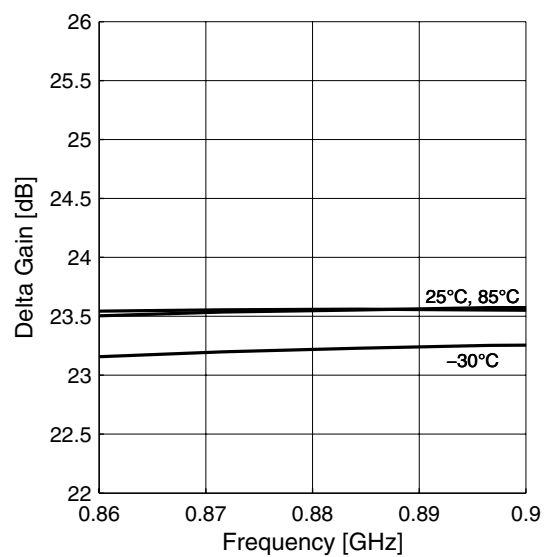
**Power Gain wideband**  $|S_{21}| = f(f)$



**Matching**  $|S_{11}| = f(f)$ ,  $|S_{22}| = f(f)$

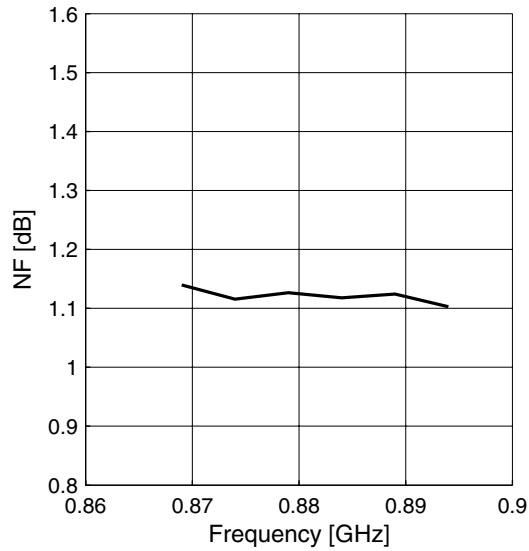


**Gainstep HG-LG**  $|\Delta S_{21}| = f(f)$

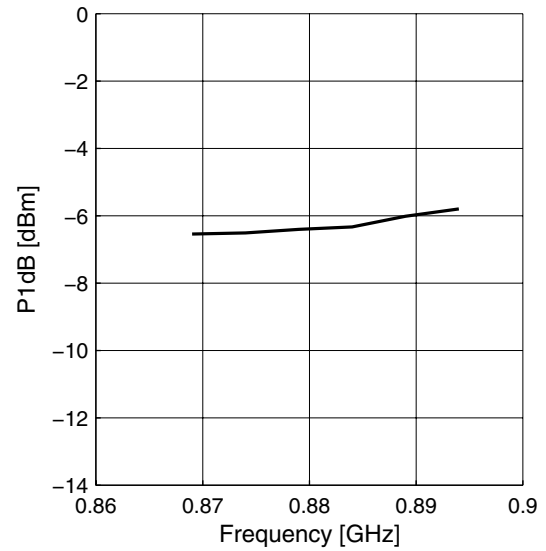


**Measured Performance Low Band (Band V) High Gain Mode vs. Temperature**

**Noise Figure**  $NF = f(f)$



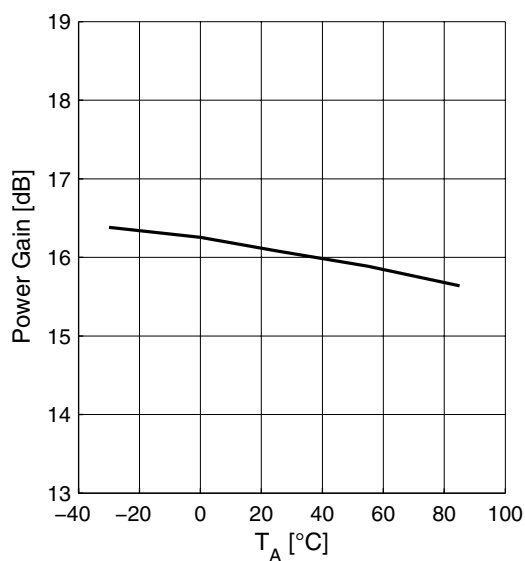
**Input Compression**  $P1dB = f(f)$



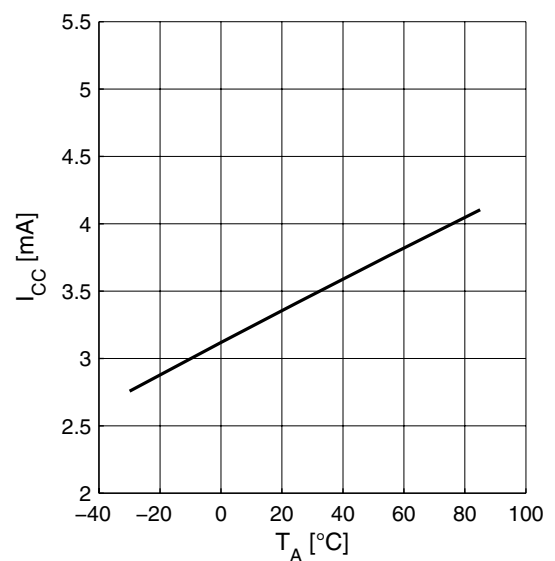
**2.12 Measured Performance Low Band (Band V) High Gain Mode vs. Temperature**

$V_{CC} = 2.8 \text{ V}$ ,  $V_{GS} = 2.8 \text{ V}$ ,  $V_{EN1} = 0 \text{ V}$ ,  $V_{EN2} = 2.8 \text{ V}$ ,  $f = 880 \text{ MHz}$

**Power Gain**  $|S_{21}| = f(T_A)$



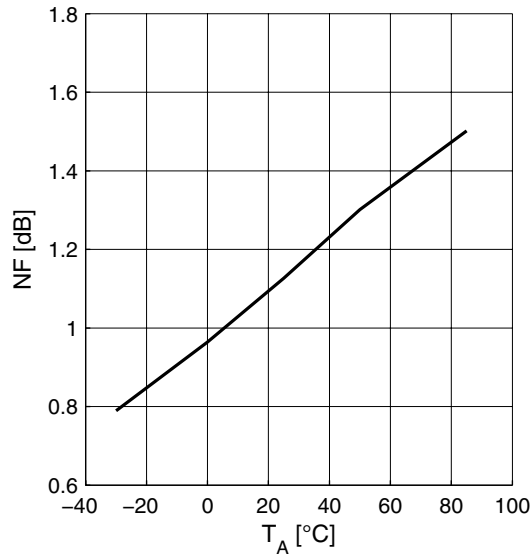
**Supply Current**  $I_{CC} = f(T_A)$



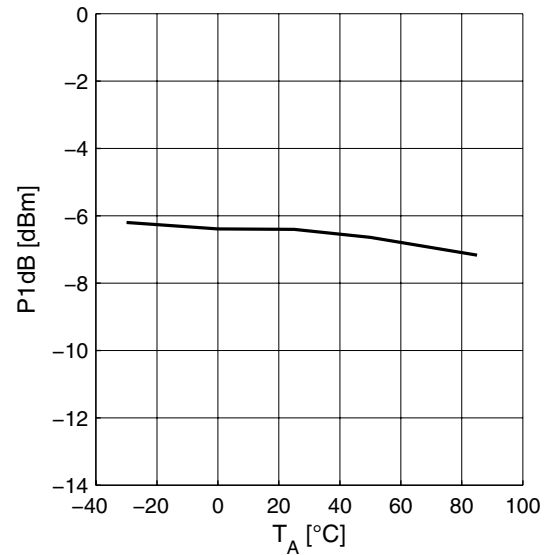


**Measured Performance Low Band (Band V) Low Gain Mode vs. Frequency**

**Noise Figure**  $NF = f(T_A)$



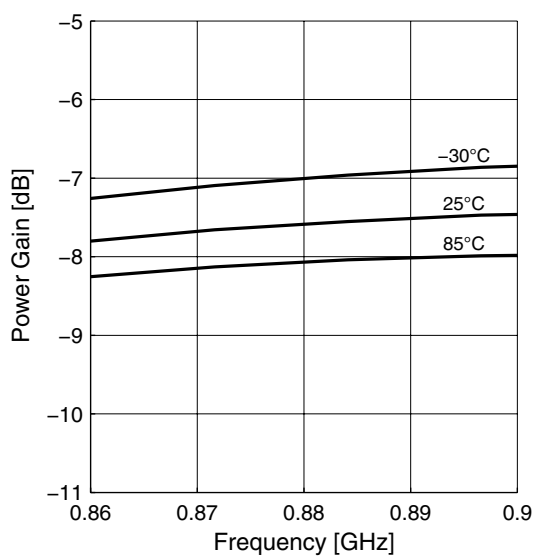
**Input Compression**  $P1dB = f(T_A)$



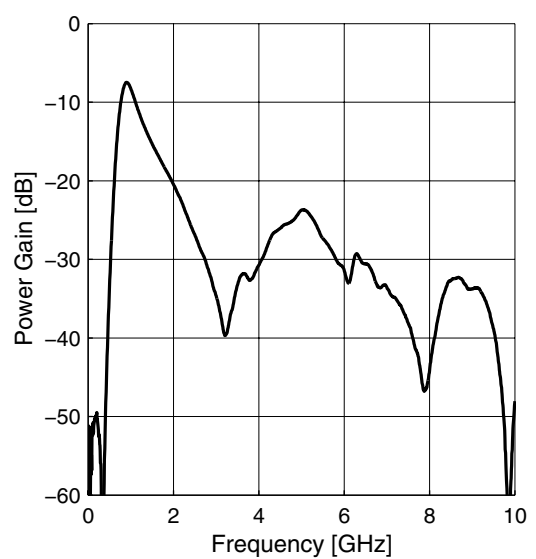
**2.13 Measured Performance Low Band (Band V) Low Gain Mode vs. Frequency**

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$ ,  $V_{GS} = 0\text{ V}$ ,  $V_{EN1} = 0\text{ V}$ ,  $V_{EN2} = 2.8\text{ V}$

**Power Gain**  $|S_{21}| = f(f)$

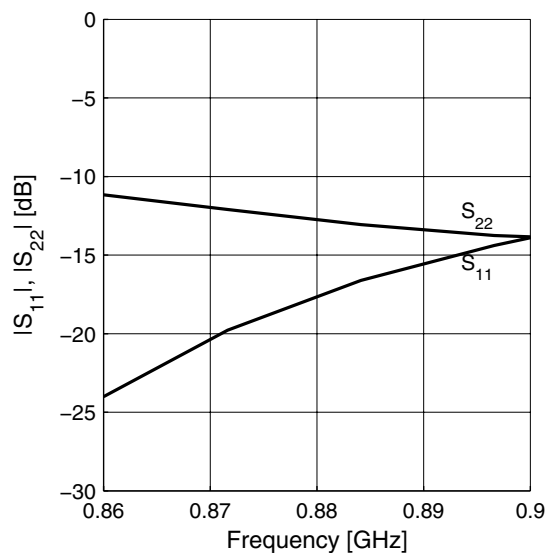


**Power Gain wideband**  $|S_{21}| = f(f)$

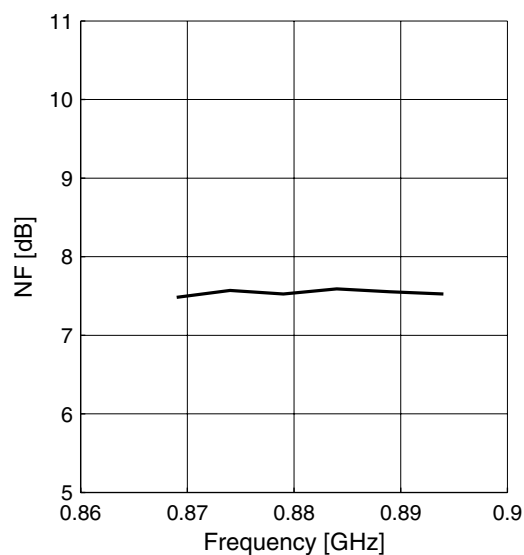


### Measured Performance Low Band (Band V) Low Gain Mode vs. Frequency

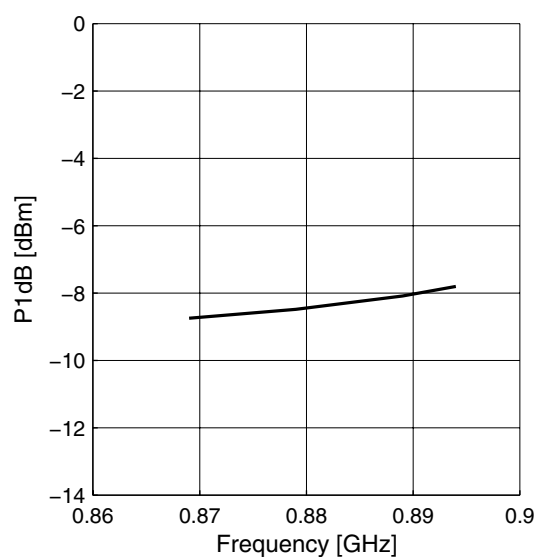
**Matching**  $|S_{11}| = f(f)$ ,  $|S_{22}| = f(f)$



**Noise Figure**  $NF = f(f)$



**Input Compression**  $P1dB = f(f)$

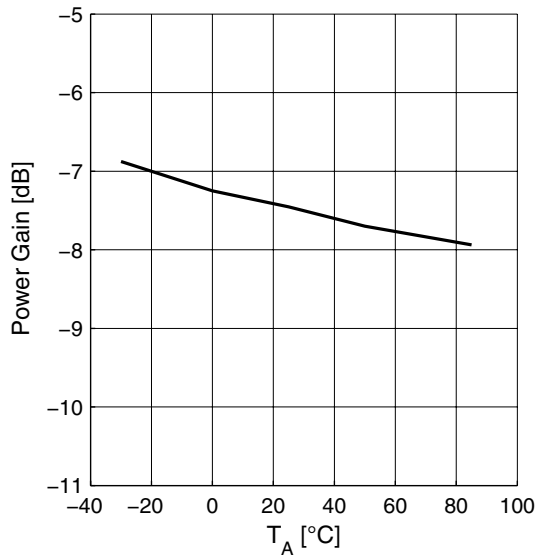


**Measured Performance Low Band (Band V) Low Gain Mode vs. Temperature**

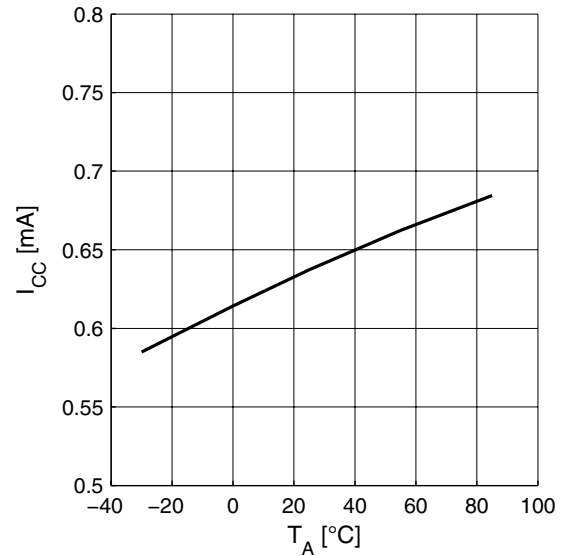
**2.14 Measured Performance Low Band (Band V) Low Gain Mode vs. Temperature**

$V_{CC} = 2.8 \text{ V}$ ,  $V_{GS} = 0 \text{ V}$ ,  $V_{EN1} = 0 \text{ V}$ ,  $V_{EN2} = 2.8 \text{ V}$ ,  $f = 880 \text{ MHz}$

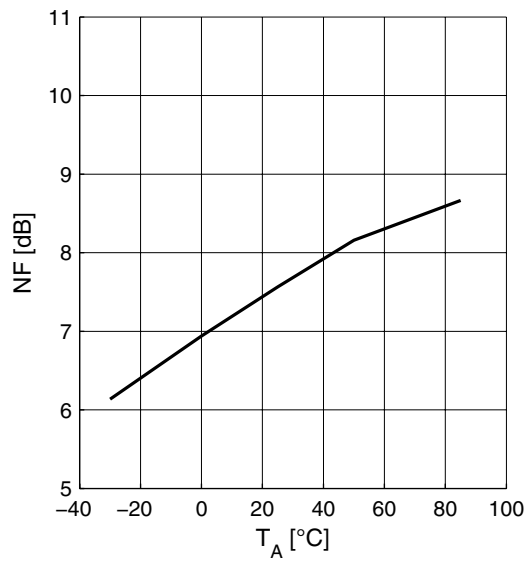
**Power Gain**  $|S_{21}| = f(T_A)$



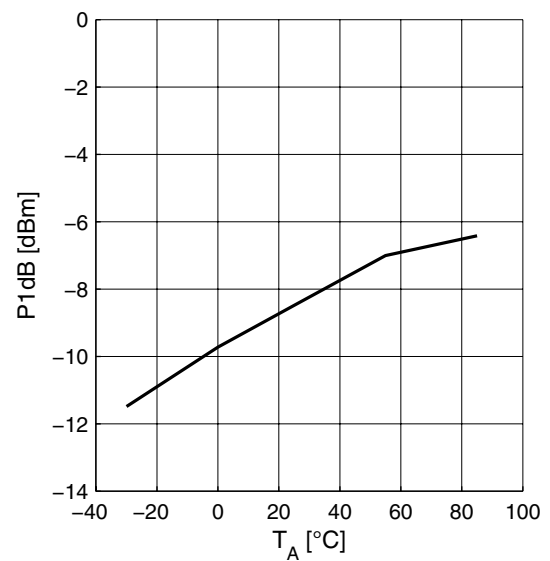
**Supply Current**  $I_{CC} = f(T_A)$



**Noise Figure**  $NF = f(T_A)$



**Input Compression**  $P1dB = f(T_A)$

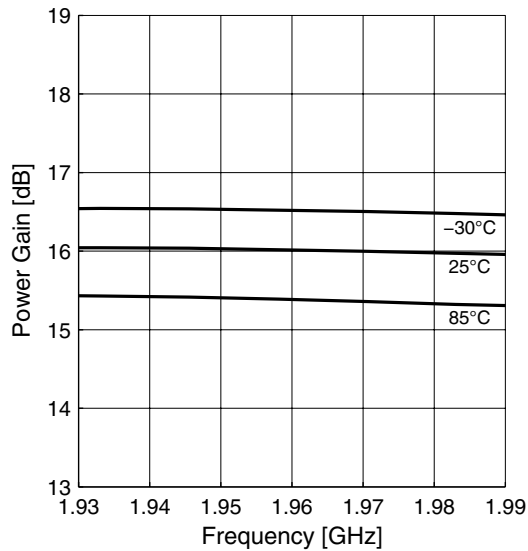


**Measured Performance Mid Band (Band II) High Gain Mode vs. Frequency**

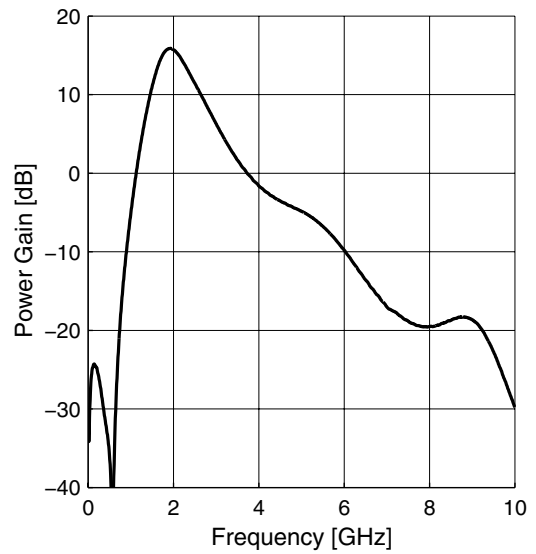
**2.15 Measured Performance Mid Band (Band II) High Gain Mode vs. Frequency**

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$ ,  $V_{GS} = 2.8\text{ V}$ ,  $V_{EN1} = 2.8\text{ V}$ ,  $V_{EN2} = 0\text{ V}$

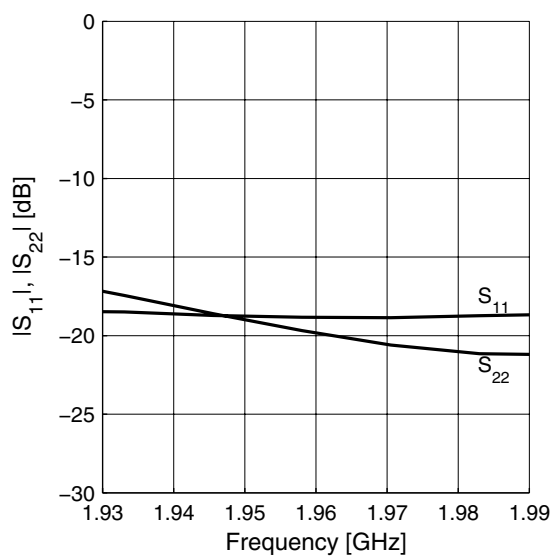
**Power Gain**  $|S_{21}| = f(f)$



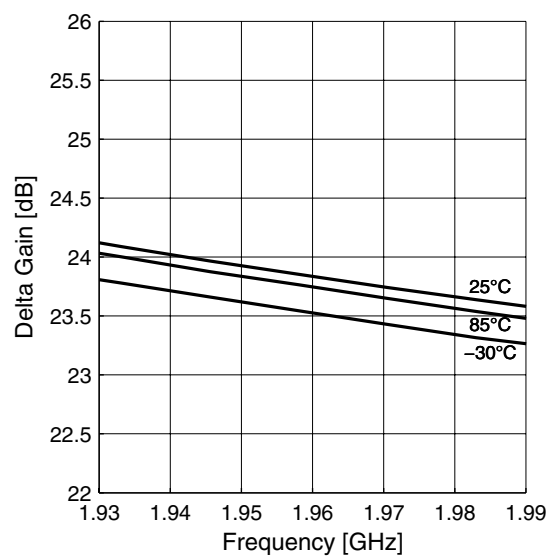
**Power Gain wideband**  $|S_{21}| = f(f)$



**Matching**  $|S_{11}| = f(f)$ ,  $|S_{22}| = f(f)$

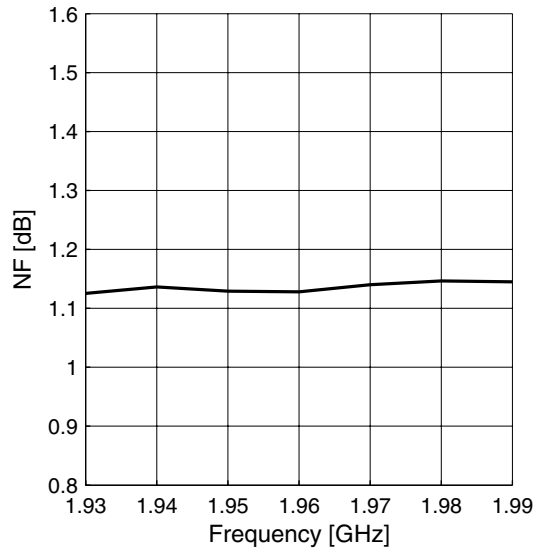


**Gainstep HG-LG**  $|\Delta S_{21}| = f(f)$

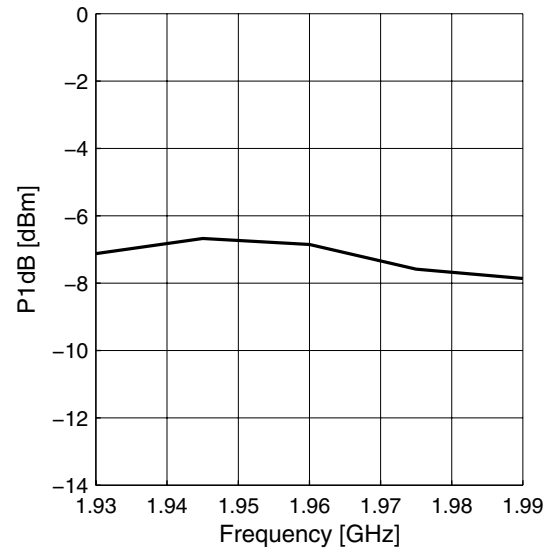


**Measured Performance Mid Band (Band II) High Gain Mode vs. Temperature**

**Noise Figure**  $NF = f(f)$



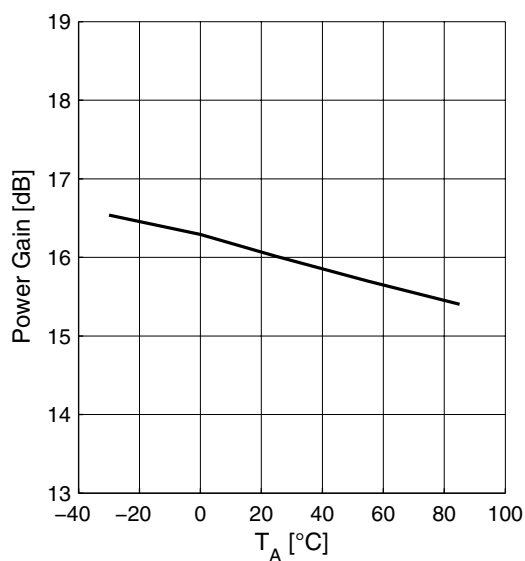
**Input Compression**  $P1dB = f(f)$



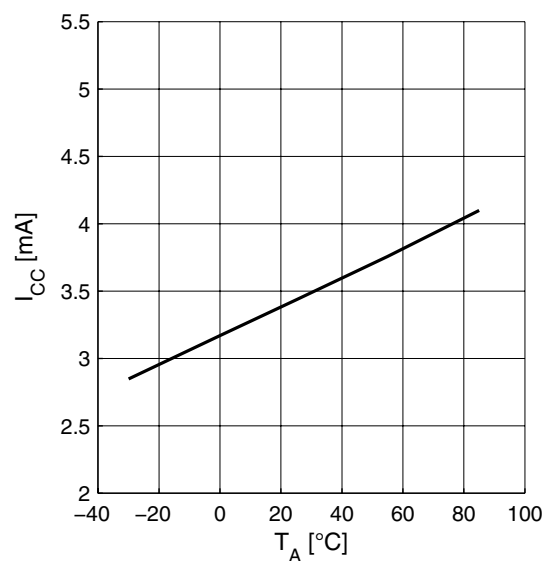
**2.16 Measured Performance Mid Band (Band II) High Gain Mode vs. Temperature**

$V_{CC} = 2.8 \text{ V}$ ,  $V_{GS} = 2.8 \text{ V}$ ,  $V_{EN1} = 2.8 \text{ V}$ ,  $V_{EN2} = 0 \text{ V}$ ,  $f = 1960 \text{ MHz}$

**Power Gain**  $|S_{21}| = f(T_A)$

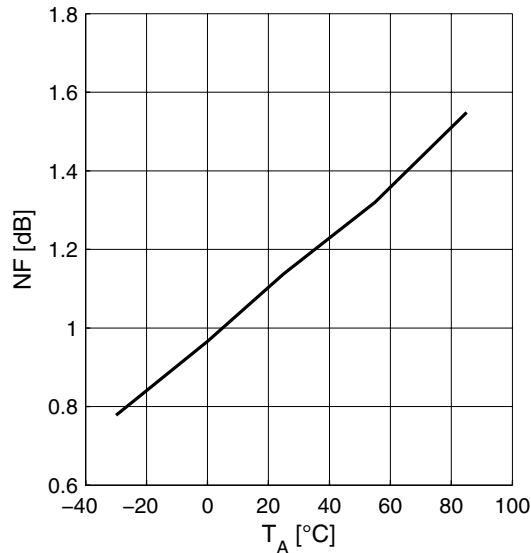


**Supply Current**  $I_{CC} = f(T_A)$

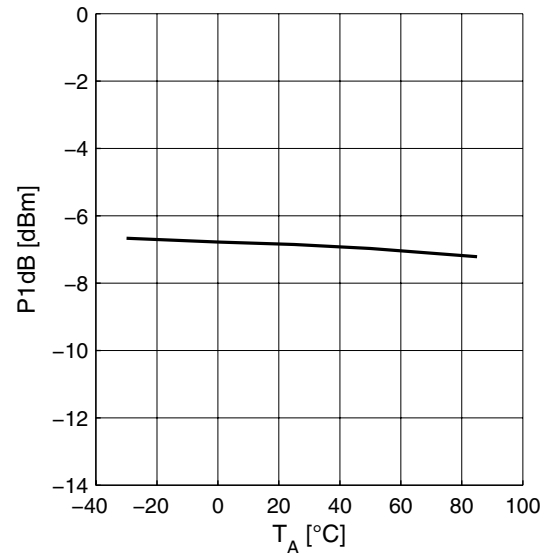


**Measured Performance Mid Band (Band II) Low Gain Mode vs. Frequency**

**Noise Figure**  $NF = f(T_A)$



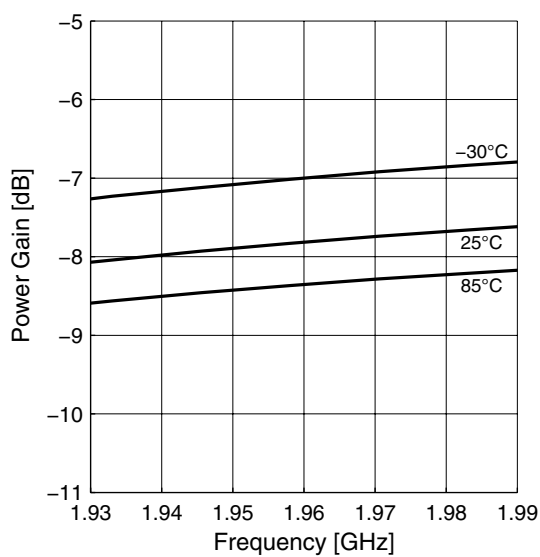
**Input Compression**  $P1dB = f(T_A)$



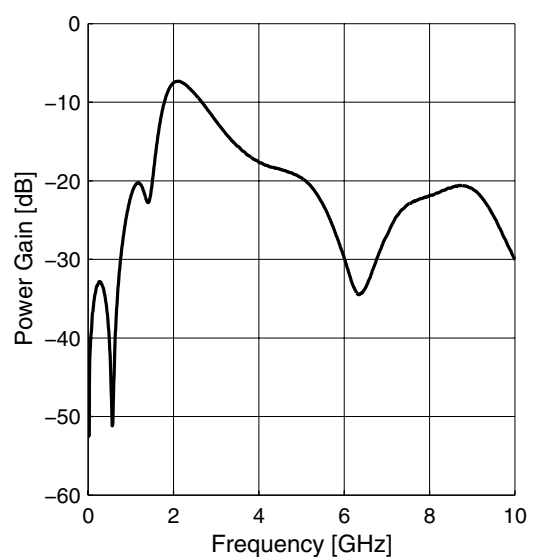
**2.17 Measured Performance Mid Band (Band II) Low Gain Mode vs. Frequency**

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = 2.8\text{ V}$ ,  $V_{GS} = 0\text{ V}$ ,  $V_{EN1} = 2.8\text{ V}$ ,  $V_{EN2} = 0\text{ V}$

**Power Gain**  $|S_{21}| = f(f)$

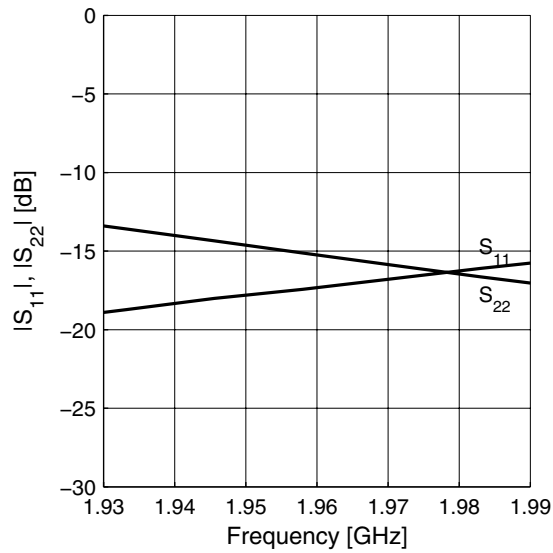


**Power Gain wideband**  $|S_{21}| = f(f)$

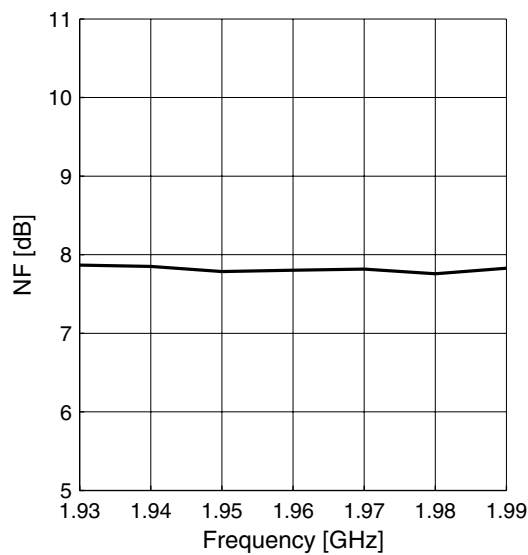


**Measured Performance Mid Band (Band II) Low Gain Mode vs. Frequency**

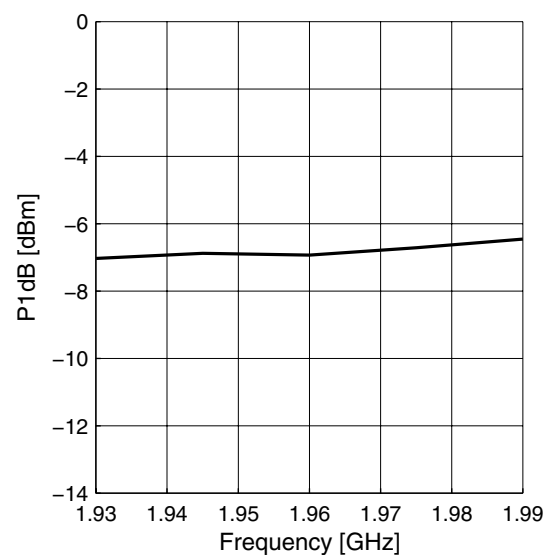
**Matching**  $|S_{11}| = f(f)$ ,  $|S_{22}| = f(f)$



**Noise Figure**  $NF = f(f)$



**Input Compression**  $P1dB = f(f)$

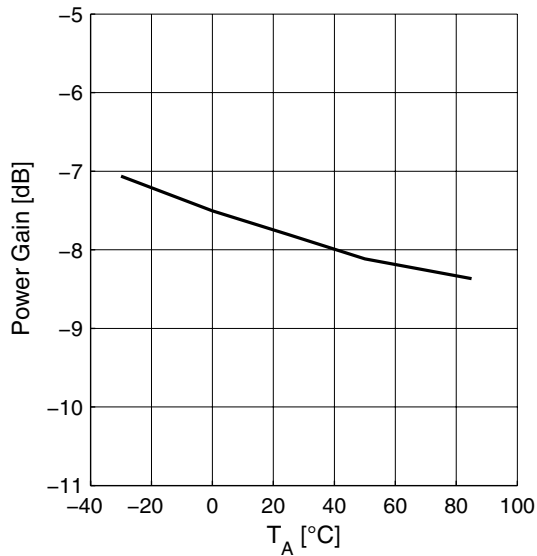


**Measured Performance Mid Band (Band II) Low Gain Mode vs. Temperature**

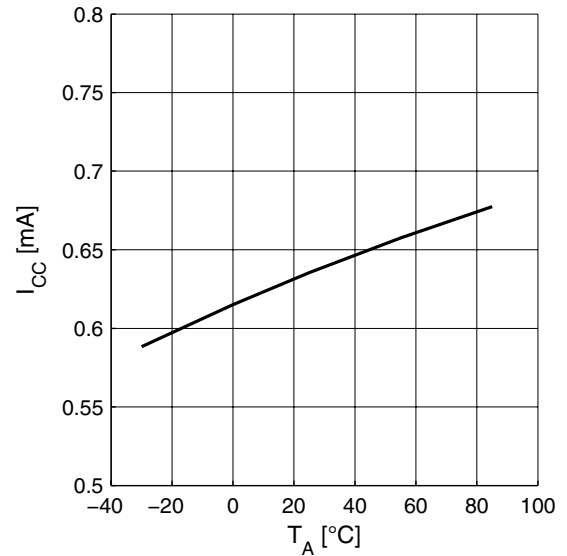
**2.18 Measured Performance Mid Band (Band II) Low Gain Mode vs. Temperature**

$V_{CC} = 2.8 \text{ V}$ ,  $V_{GS} = 0 \text{ V}$ ,  $V_{EN1} = 2.8 \text{ V}$ ,  $V_{EN2} = 0 \text{ V}$ ,  $f = 1960 \text{ MHz}$

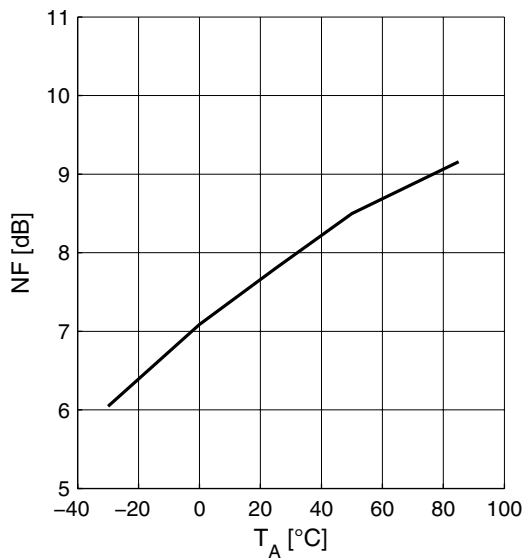
**Power Gain**  $|S_{21}| = f(T_A)$



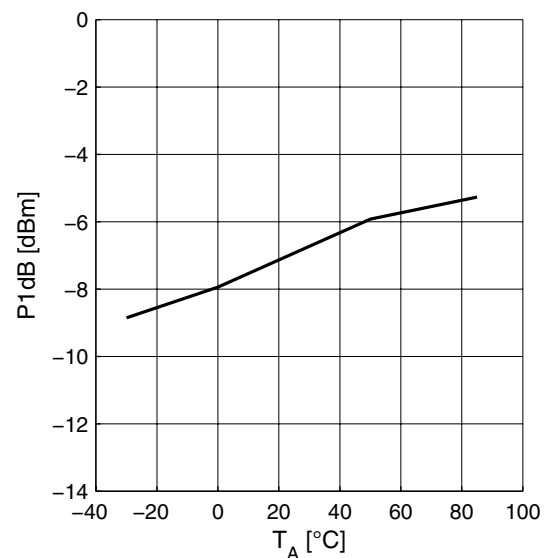
**Supply Current**  $I_{CC} = f(T_A)$



**Noise Figure**  $NF = f(T_A)$



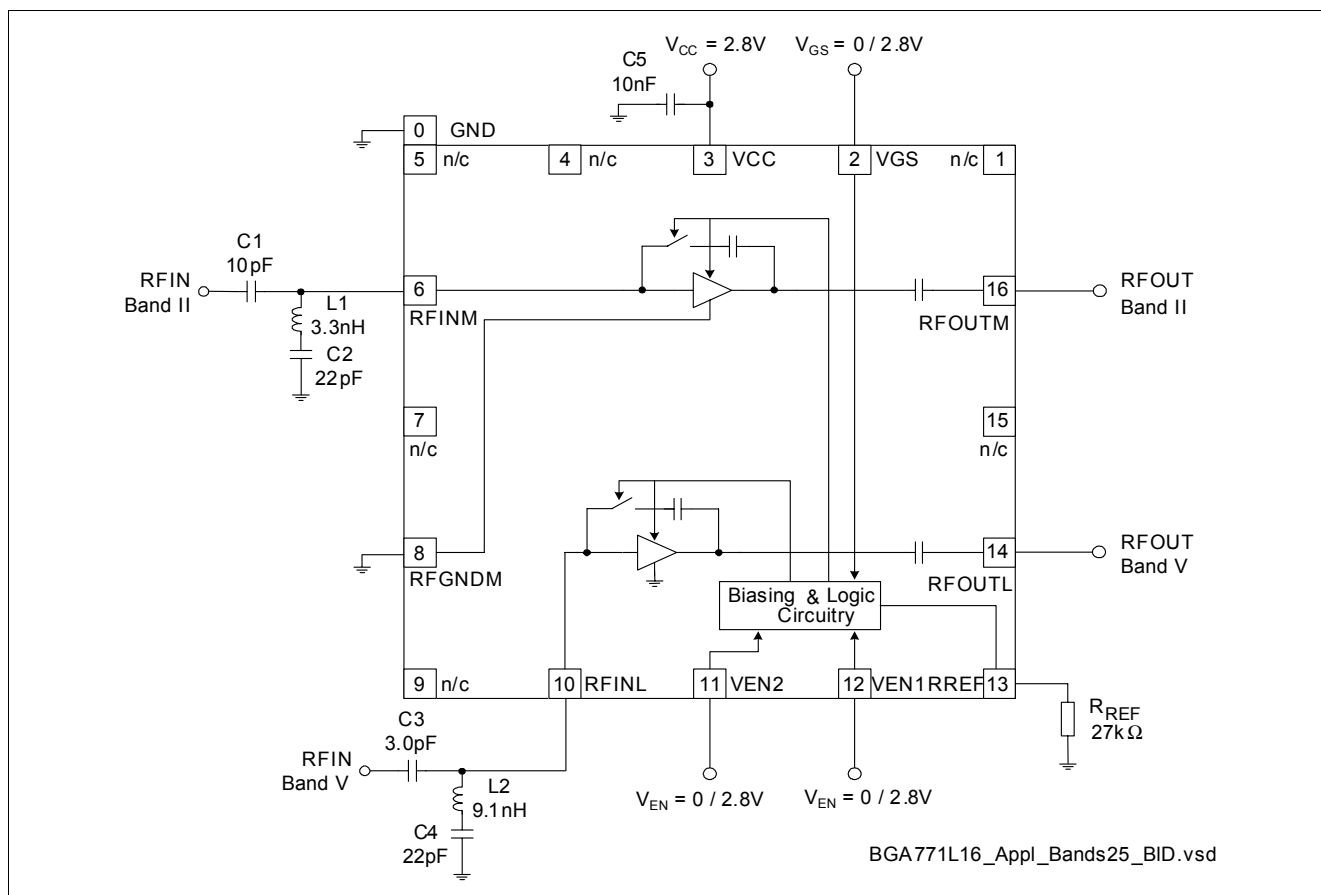
**Input Compression**  $P1dB = f(T_A)$





## 3 Application Circuit and Block Diagram

### 3.1 UMTS bands II and V Application Circuit Schematic



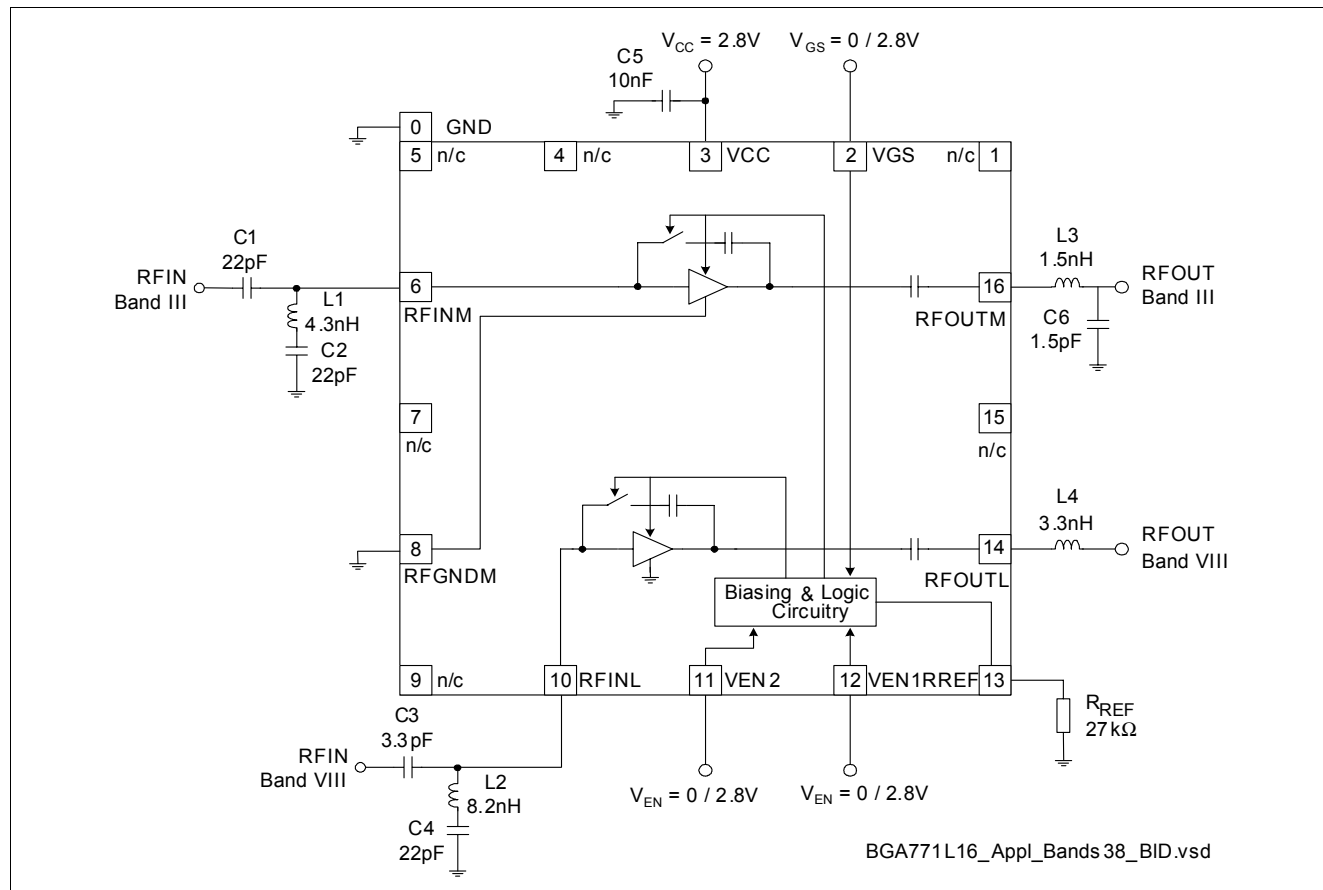
**Figure 2 Application circuit with chip outline (top view)**

*Note: Package paddle (Pin 0) has to be RF grounded.*

**Table 13 Parts List**

| Part Number | Part Type      | Manufacturer | Size | Comment                   |
|-------------|----------------|--------------|------|---------------------------|
| L1 ... L2   | Chip inductor  | Various      | 0402 | Wirewound, $Q \approx 50$ |
| C1 ... C5   | Chip capacitor | Various      | 0402 |                           |
| RREF        | Chip resistor  | Various      | 0402 |                           |

## 3.2 UMTS bands III and VIII Application Circuit Schematic



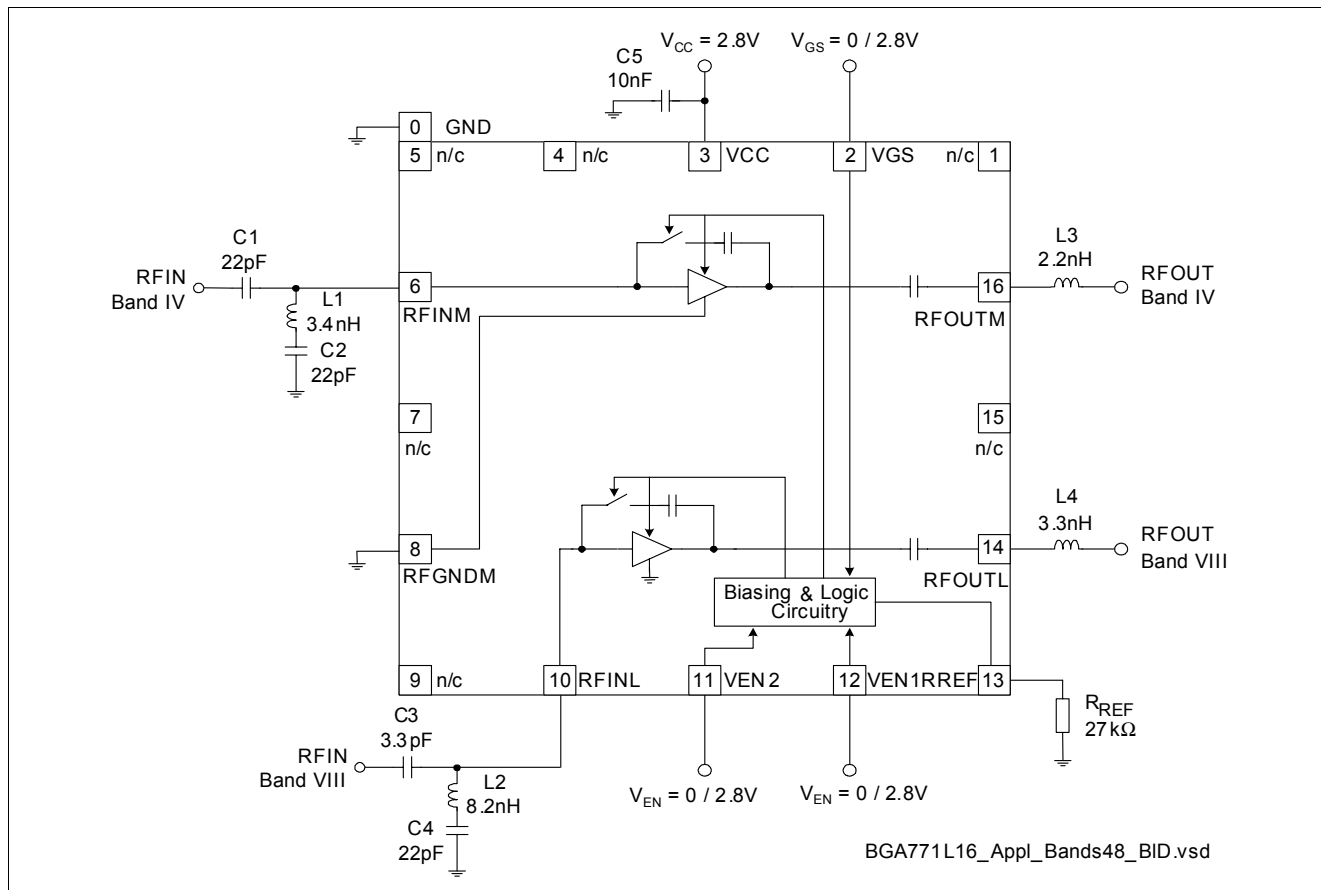
**Figure 3 Application circuit with chip outline (top view)**

*Note: Package paddle (Pin 0) has to be RF grounded.*

**Table 14 Parts List**

| Part Number | Part Type      | Manufacturer | Size | Comment           |
|-------------|----------------|--------------|------|-------------------|
| L1 ... L4   | Chip inductor  | Various      | 0402 | Wirewound, Q ≈ 50 |
| C1 ... C6   | Chip capacitor | Various      | 0402 |                   |
| RREF        | Chip resistor  | Various      | 0402 |                   |

### 3.3 UMTS bands IV and VIII Application Circuit Schematic



**Figure 4** Application circuit with chip outline (top view)

Note: Package paddle (Pin 0) has to be RF grounded.

**Table 15** Parts List

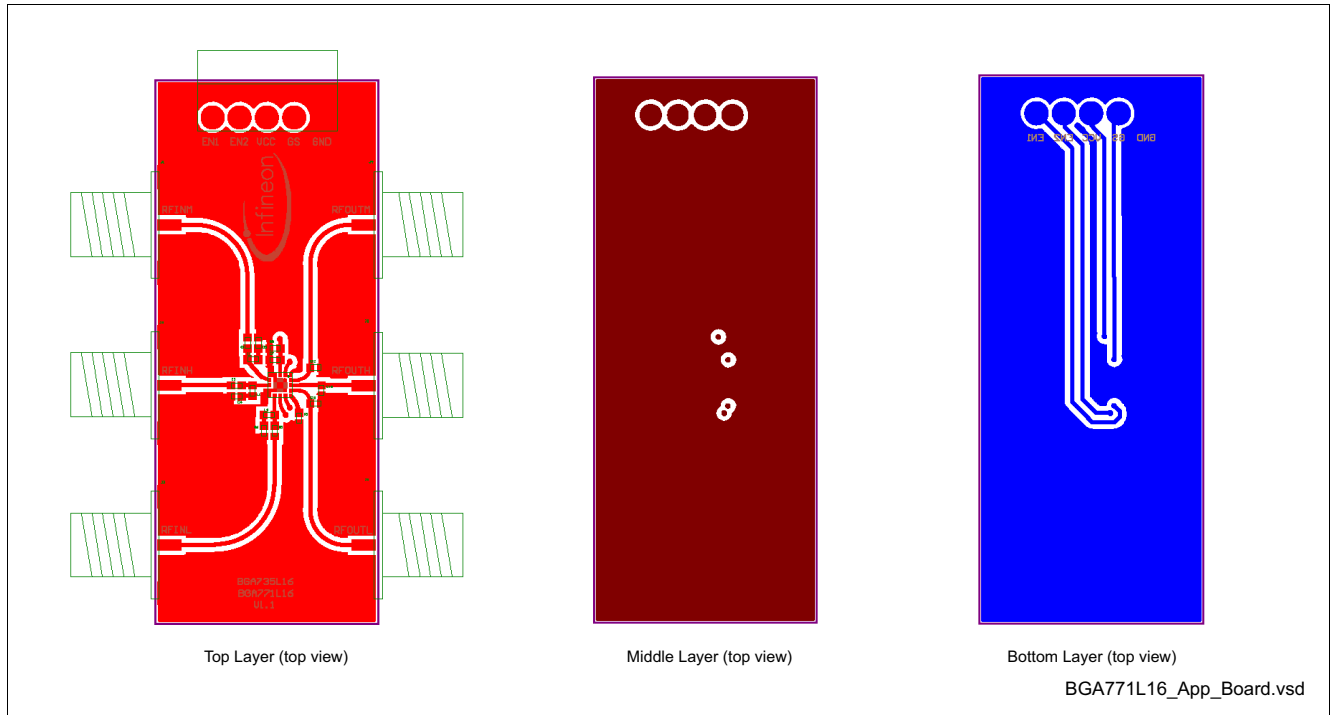
| Part Number | Part Type      | Manufacturer | Size | Comment           |
|-------------|----------------|--------------|------|-------------------|
| L1 ... L4   | Chip inductor  | Various      | 0402 | Wirewound, Q ≈ 50 |
| C1 ... C5   | Chip capacitor | Various      | 0402 |                   |
| RREF        | Chip resistor  | Various      | 0402 |                   |

### 3.4 Pin Definition

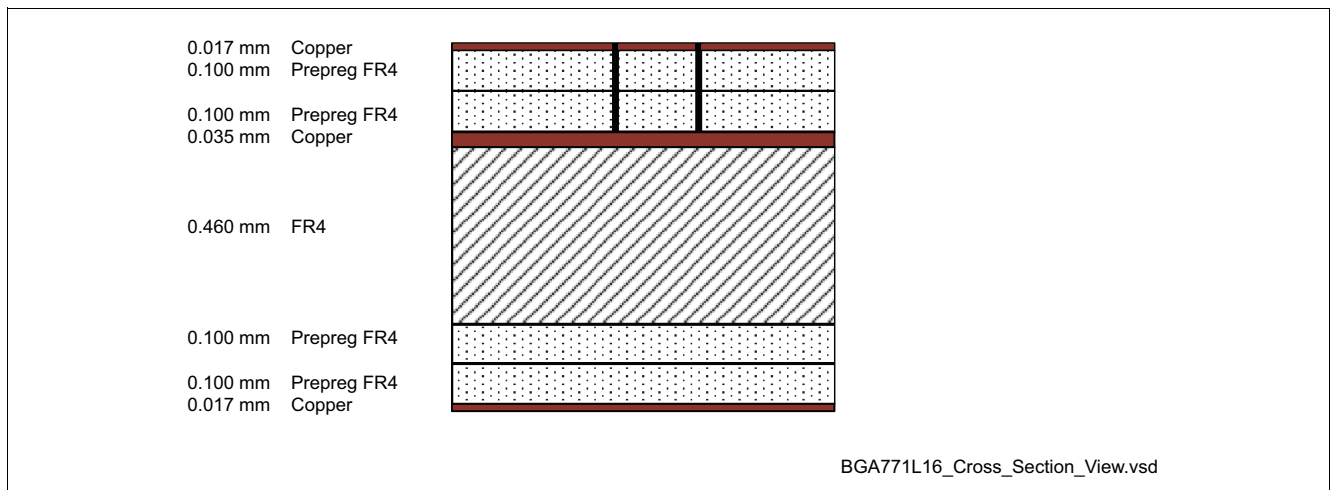
**Table 16 Pin Definition and Function**

| Pin Number | Symbol | Function                                                                 |
|------------|--------|--------------------------------------------------------------------------|
| 0          | GND    | Package paddle; ground connection for low band LNA and control circuitry |
| 1          | n/c    | Not connected                                                            |
| 2          | VGS    | Gain step control                                                        |
| 3          | VCC    | Supply voltage                                                           |
| 4          | n/c    | Not connected                                                            |
| 5          | n/c    | Not connected                                                            |
| 6          | RFINM  | Mid band (1900/1800/2100 MHz) LNA input                                  |
| 7          | n/c    | Not connected                                                            |
| 8          | RFGNDM | Mid band LNA emitter ground                                              |
| 9          | n/c    | Not connected                                                            |
| 10         | RFINL  | Low band (800/900 MHz) LNA input                                         |
| 11         | VEN2   | Band select control                                                      |
| 12         | VEN1   | Band select control                                                      |
| 13         | RREF   | Bias current reference resistor (high gain mode)                         |
| 14         | RFOUTL | Low band (800/900 MHz) LNA output                                        |
| 15         | n/c    | Not connected                                                            |
| 16         | RFOUTM | Mid band (1900/1800/2100 MHz) LNA output                                 |

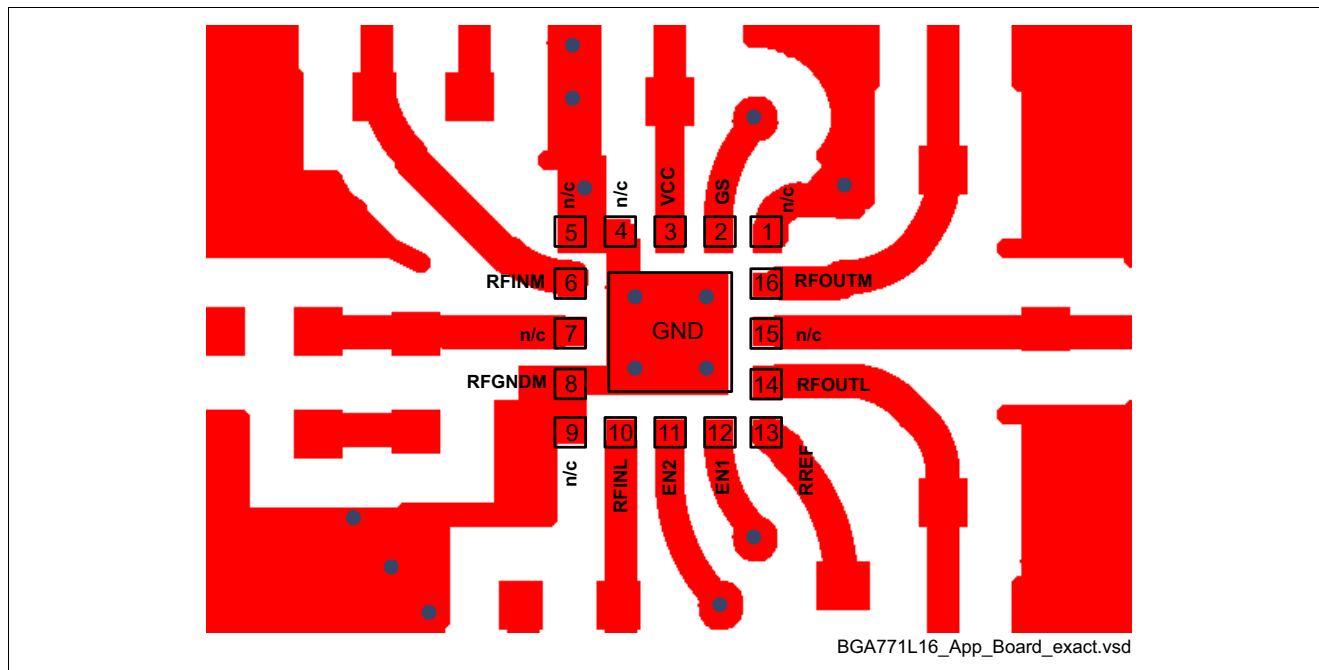
### 3.5 Application Board



**Figure 5** Application board layout on 3-layer FR4. Top layer thickness: 0.2 mm, bottom layer thickness: 0.8 mm, 17  $\mu\text{m}$  Cu metallization, gold plated. Board size: 21 x 50 mm



**Figure 6** Cross-section view of application board

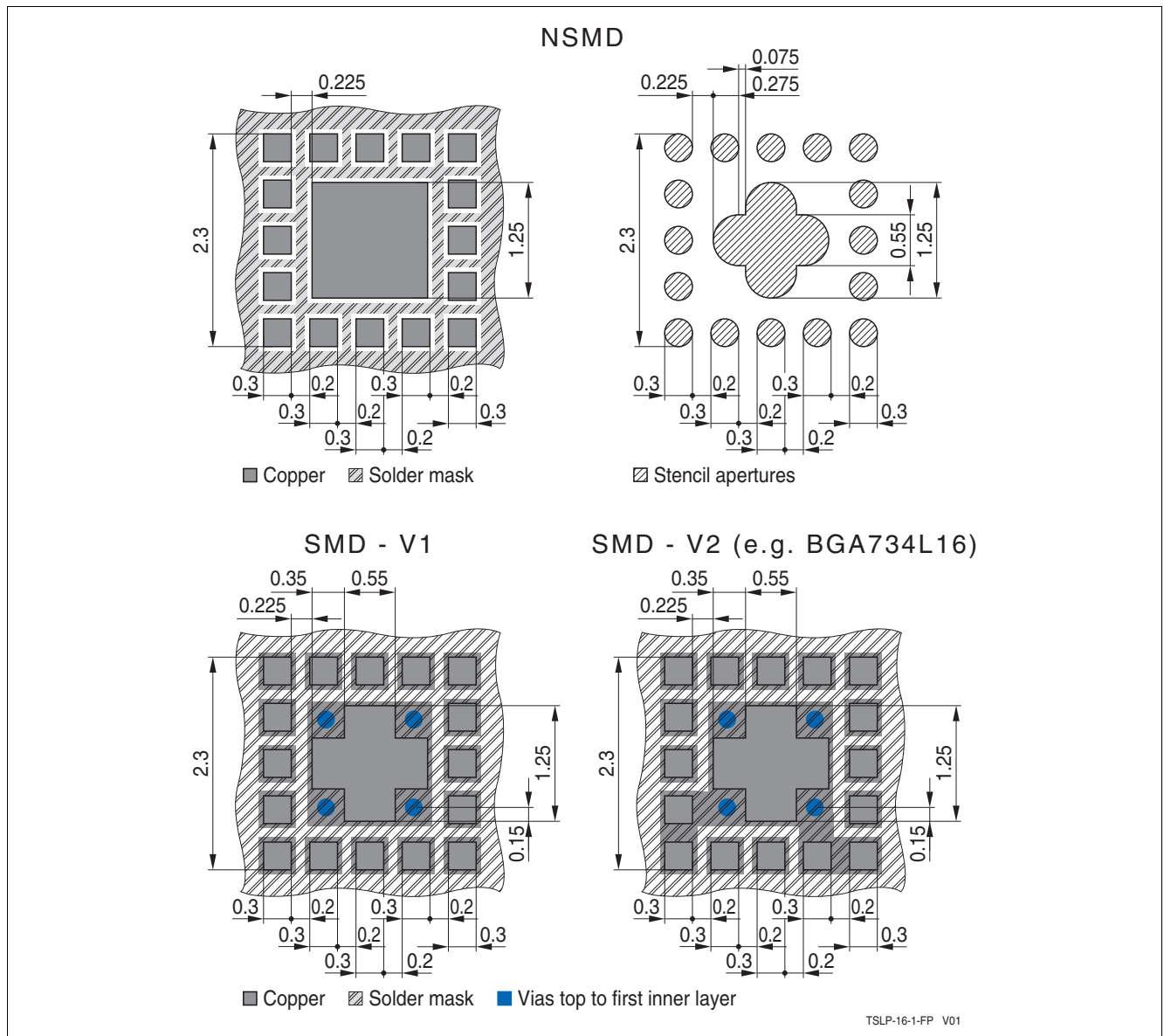


**Figure 7** Detail of application board layout

*Note: In order to achieve the same performance as given in this datasheet please follow the suggested PCB-layout as closely as possible. The position of the GND vias is critical for RF performance.*

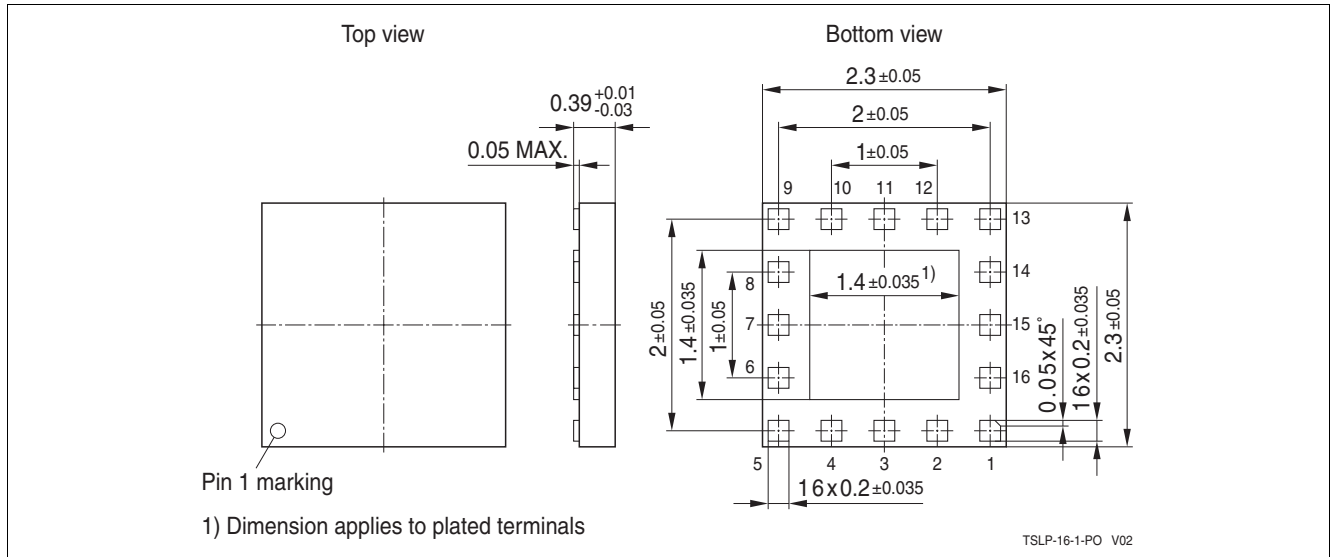
## 4 Physical Characteristics

## 4.1 Package Footprint



**Figure 8 Recommended footprint and stencil layout for the TSLP-16-1 package**

## 4.2 Package Dimensions



**Figure 9** Package outline (top, side and bottom view)



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